



**EXPEDITED PROCEDURE – EXAMINING GROUP 2835**

**PATENT**

S/N 10/607,783

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Mike G MacGregor	Examiner:	Corey M. Broussard
Serial No.:	10/607,783	Group Art Unit:	2835
Filed:	June 27, 2003	Docket No.:	884.940US1
Title:	HEAT SINK ASSEMBLY AND METHOD OF ATTACHING A HEAT SINK TO AN ELECTRONIC DEVICE ON A MOTHERBOARD		
Assignee:	Intel Corporation	Customer No:	21186

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**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

MS RCE  
Commissioner for Patents  
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This paper responds to the Final Office Action mailed on July 20, 2005. Please amend the above-identified patent application as follows.